MacPherson, Kwok Chen & Heid LLP

2402 Michelson Drive, Suite 210

<u>Irvine, California 92612</u>

Tel.: 949-752-7040 Fax: 949-752-7049

Email: gmichelson@macpherson-kwok.com

Docket No.: M-15301 US



Mail Stop Patent Application Commissioner For Patents P.O. Box 1450 Alexandria, VA 22313-1450

Enclosed herewith for filing is a patent application, as follows:

Inventor(s):

Shu Yuan; Thomas A. Peterson; Kevin E. Sallese

Title:

Fast Diagonal Interleaved Parity (DIP) Calculator

16.

Return Receipt Postcard

X This Transmittal Letter (in duplicate)

X Fourteen (14) page(s) Specification (not including claims)

X Four (4) page(s) Claims

X One (1) page Abstract

X Four (4) sheet(s) of drawings including Figures 1, 2, 3, 4, and 5

X Two (2) page(s) Executed Declaration For Patent Application and Power of Attorney

X Recordation Form Cover Sheet

X Two (2) pages of Executed Assignment

X Request for Non-Publication

CLAIMS AS FILED

For Total Claims	Number <u>Filed</u> 16	-20	=	Number <u>Extra</u> 0	x	Rate \$18.00	=	\$. \$	Basic Fee <u>770.00</u> 0.00
Independent Claims	2	-3	=	0	x	\$86.00		\$	0.00
Fee ofmultiple de	for the first fependent claims	iling of per app	one o	or more				\$	
Fee for Request for Extension of Time					. \$				

\boxtimes	Total fee	for filing	the patent	application	in the	amount	of
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The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 50-2257.

<u>\$770.00</u>

EXPRESS MAIL LABEL NO:

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Respectfully submitted,

Jon W. Hallman

Attorney for Applicants

Reg. No. 42,622

22856 U.S. PTO 10/791073

MODIFIED PTO/SB/35 (11-00)

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

Inventor		Shu Yuan; Thomas A. Peterson; Kevin E. Sallese				
Title	Fast Diagonal Interleaved Parity (DIP) Title Calculator					
Atty D	ocket	Number M-15301 US				

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

March 1, 2004 Date

Jon W. Hallman Attorney for Applicants Reg. No.: 42,622

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).